Power GaN Cascode Transistor 600 V, 290 m Ω

Features

- Fast Switching
- Extremely Low Q_{rr}
- Transphorm Inside
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

ON

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V _{(BR)DSS}	R _{DS(ON)} TYP
600 V	290 mΩ @ 10 V

ABSOLUTE MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

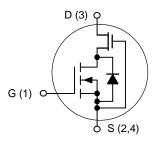
Para	Parameter				
Drain-to-Source Volta	V _{DSS}	600	V		
Gate-to-Source Volta	V _{GS}	±18	V		
Continuous Drain	Steady State	$T_C = 25^{\circ}C$	Ι _D	9.0	А
Current R _{0JC}	Sidle	$T_C = 100^{\circ}C$		6.0	
Power Dissipation – $R_{\theta JC}$	Steady State	$T_C = 25^{\circ}C$	P _D	65	W
Pulsed Drain Current	t _p =	= 10 μs	I _{DM}	35	A
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to +150	°C
Lead Temperature for	Soldering	Leads	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

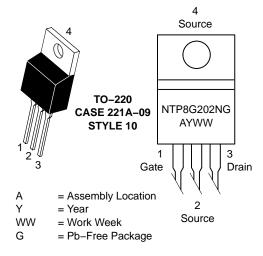
THERMAL RESISTANCE

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{\theta JC}$	2.3	°C/W
Junction-to-Ambient Steady State	R_{\thetaJA}	62	°C/W





MARKING DIAGRAM & PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping
NTP8G202NG	TO-220 (Pb-Free)	50 Units / Rail

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Test Conditions		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 r	nA	600			V
Drain-to-Source Leakage Current	I _{DSS}	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	$T_J = 25^{\circ}C$		2.5	90	μΑ
			$T_J = 150^{\circ}C$		8.0		
Gate-to-Source Leakage Current	I _{GSS}	V _{GS} = ±18 V				±100	nA
ON CHARACTERISTICS (Note 1)					-		-
Gate Threshold Voltage	V _{GS(TH)}	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 500$	Ο μΑ	1.6	2.1	2.6	V
Static Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 8 V, I _D = 5.5	δA		290	350	mΩ
DYNAMIC CHARACTERISTICS		•			-	-	-
Input Capacitance	C _{iss}	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz			760		pF
Output Capacitance	C _{oss}				26		
Reverse Transfer Capacitance	C _{rss}				3.5		
Effective output capacitance, energy related (Note 3)	C _{o(er)}	V_{GS} = 0 V, V_{DS} = 0 to 480 V			36		
Effective output capacitance, time related (Note 4)	C _{o(tr)}	I_D = constant, V_{GS} = 0 V, V_{DS} = 0 to 480 V			57		
Total Gate Charge	Qg				6.2	9.3	nC
Gate-to-Source Charge	Q _{gs}	V_{DS} = 100 V, I _D = 5.5 A, V _{GS} = 4.5 V			2.1		1
Gate-to-Drain Charge	Q _{gd}				2.2		1
SWITCHING CHARACTERISTICS (Note		•			•		-
Turn-on Delay Time	t _{d(on)}				6.2		ns

Turn-on Delay Time	t _{d(on)}		6.2	ns
Rise Time	t _r	V _{DD} = 480 V, I _D = 5.5 A,	4.5	
Turn-off Delay Time	t _{d(off)}	$\overline{V_{GS}}$ = 10 V, \overline{R}_{G} = 2 Ω	9.7	
Fall Time	t _f		5.0	

SOURCE-DRAIN DIODE CHARACTERISTICS

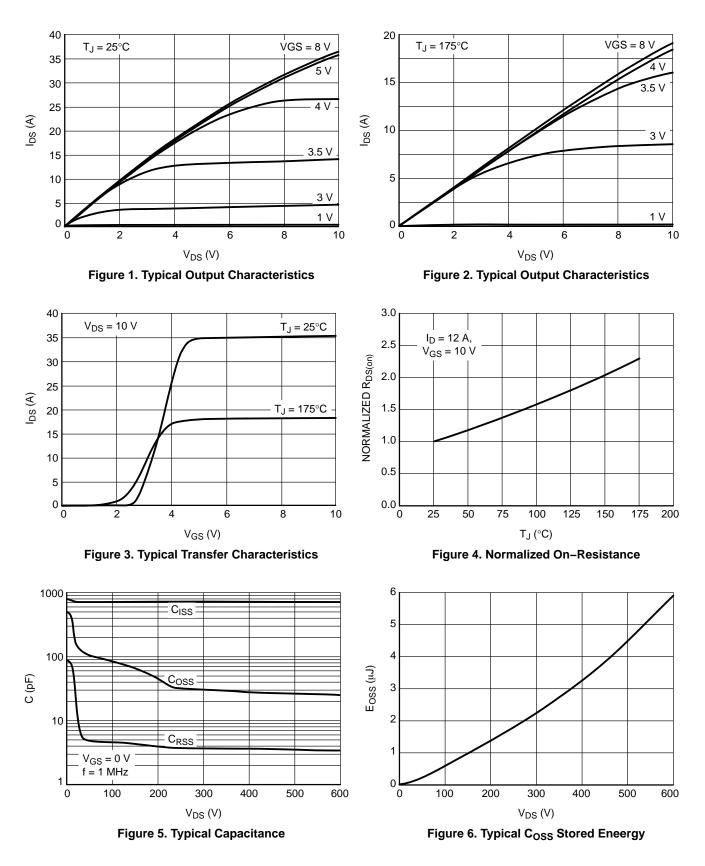
Diode Forward Voltage	V _{SD}	$I_{S} = 5.5 \text{ A}, V_{GS} = 0 \text{ V}$	$T_J = 25^{\circ}C$	2.1	V
Reverse Recovery Time	t _{rr}	V _{GS} = 0 V, V _{DD} = 48	30 V	12	ns
Reverse Recovery Charge	Q _{rr}	$I_{\rm S} = 5.5 \rm A, d_i/d_t = 1500$		29	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Width \leq 300 µs, Duty Cycle \leq 2%.

2. Switching characteristics are independent of operating junction temperatures. 3. $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$ 4. $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(BR)DSS}$

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

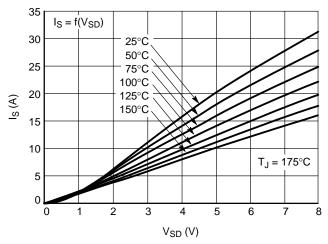


Figure 7. Forward Characteristics of Rev. Diode

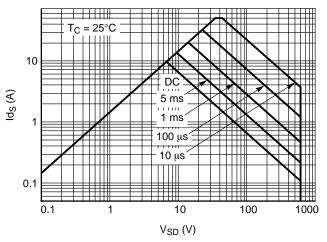


Figure 8. Safe Operating Area

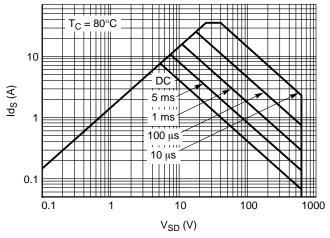


Figure 9. Safe Operating Area

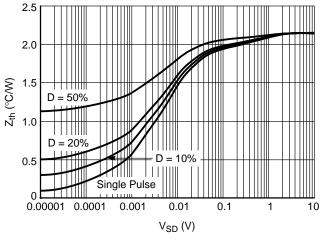


Figure 10. Transient Thermal Resistance

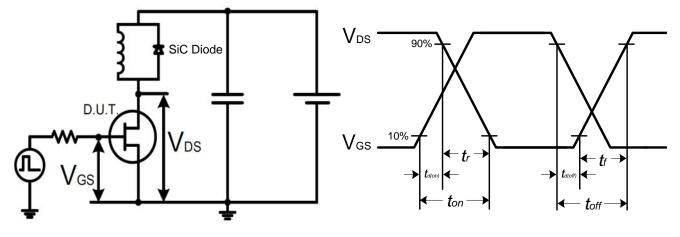


Figure 11. Switching Time Test Circuit

Figure 12. Switching Time Waveform

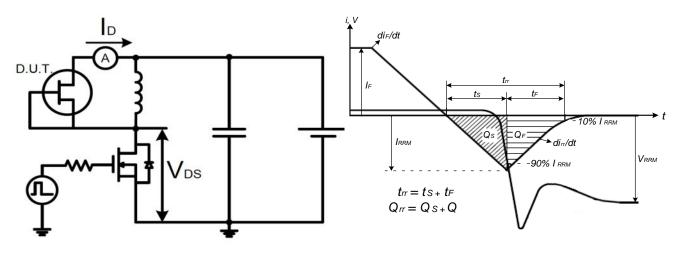
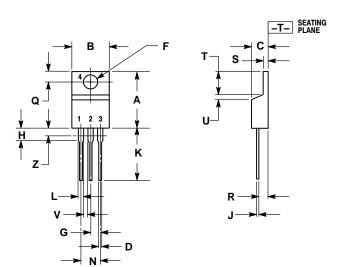


Figure 13. Test Circuit for Reverse Diode Characteristics

Figure 14. Diode Recovery Waveform

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH**



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI 2

V14.5M, 1982. CONTROLLING DIMENSION: INCH. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE 3. ALLOWED.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.415	9.66	10.53	
С	0.160	0.190	4.07	4.83	
D	0.025	0.038	0.64	0.96	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
н	0.110	0.161	2.80	4.10	
J	0.014	0.024	0.36	0.61	
Κ	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
۷	0.045		1.15		
Z		0.080		2.04	

STYLE 10: PIN 1. GATE

2. SOURCE DRAIN 3. SOURCE 4.

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